

目録 MAPX	設定内容 MODIFICATION	日期 DATE
A0	NEW	09-10-20

NOTES:

1. MATERIAL:

MOLDING: LCP UL94 V-0
CONTACT: COPPER ALLOY.

GOLD PLATING ALL OVER 50u" Min NICKEL
AND 100u" Min Tin ALL OVER 50u" Min NICKEL
ON SOLDER AREA

SHELL: SUS304-H, $T=0.30\pm0.03\text{mm}$

50u" NICKEL PLATING OVER ALL.
SHILD: SUS304-H,T=0.12±0.03mm

2. MECHANICAL:

INSERTION: 5~20N.

EXTRACTION: 8~20N AFTER TEST.

DURABILITY: 10000 CYCLES

3. ELECTRICAL:

CURRENT: 5A FOR VBUS;

1.25A FOR GND PIN.

0.25A FOR OTHER.

VOLTAGE: 20 V MAX

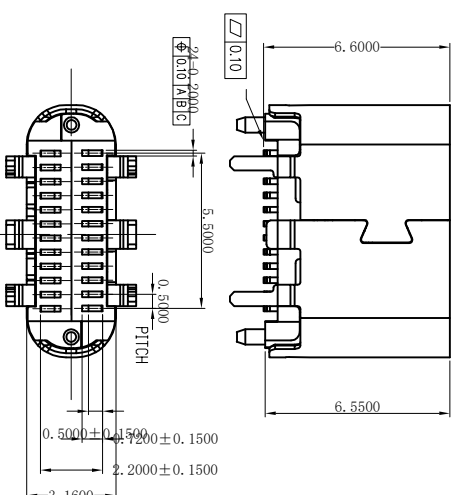
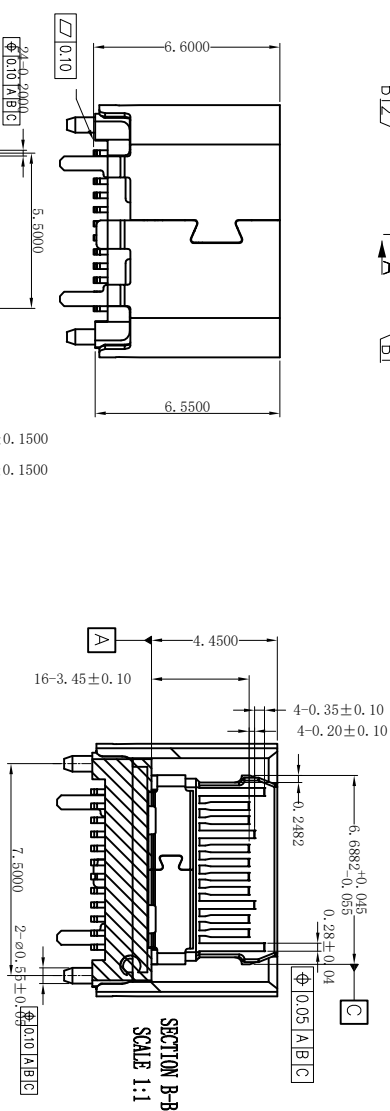
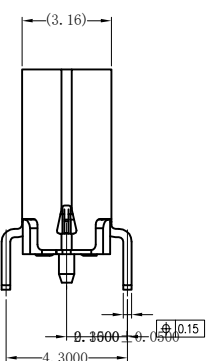
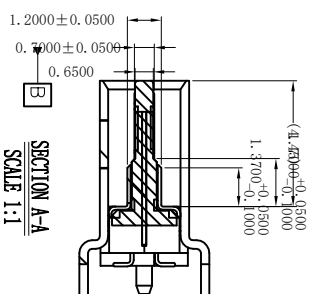
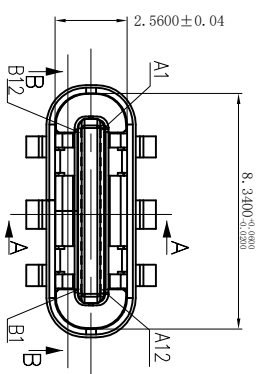
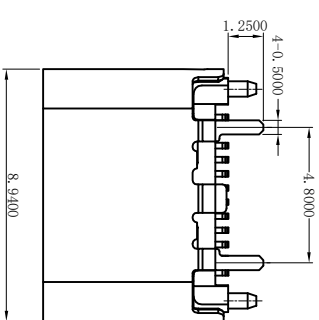
WITHSTANDING VOLTAGE: 100V AC R.M.S.

CONTACT RESISTANCE: 40mΩ MAX.

INSULATION RESISTANCE: 100M Ω MIN.

4. ENVIRONMENTAL

TEMPERATURE RANGE -55°C $\sim$ $+85^{\circ}\text{C}$



A1	GND	B12	GND
A2	ST1XP1	B11	SSRXP1
A3	SST1XN1	B10	SSRXN1
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A10	SSRXN2	B3	SST1XN2
A11	SSRXP2	B2	ST1XP2
A12	GND	B1	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

产 品 图				深圳市鑫风雷电子有限公司										
PRODUCT CHART DWG														
公差一览表				单位	MM	制图	王 冠	产品料号	O1002-UGAF008-X					
TOLERANCE UNLESS OTHERWISE				UNITS		DRAWING		PRODUCT PART NO.						
X.	±0.30	X.	±5°	比例	1:1	审核	雷永健	产品名称	TYPE O 24P母座立式SMT H=6.5					
.X.	±0.25	.X°	±2°	SCALE		工程		PRODUCT NO.						
.XX	±0.20	.XX°	±1°	日期	2009/10/20	图法		图法	版本					
.XXX	±0.15	.XXX°	±0.5°	DATE		APPD		VIEW			版本	VER	A0	